

5 *11* a package having a pair of opposed upright ends, said package connected to any of said at  
6 least one battery and said at least one integrated circuit chip.

---

7

1 5. (As Amended) A system level device for battery and integrated circuit chip integration  
2 comprising:

3 at least one battery;

4 at least one integrated circuit chip powered by said at least one battery; and

5 a package connected to any of said at least one battery and said at least one integrated  
6 circuit chip,

7 wherein said at least one battery connects to a pair of opposed upright ends of said  
8 package.

---

1

1 7. (As Amended) A system level device for battery and integrated circuit chip integration  
2 comprising:

3 a multi-chip module integration system, wherein said multi-chip module integration  
4 system comprises:

5 a multi-chip module having a pair of opposed upright ends;

6 at least one battery connected to said multi-chip module; and

7 at least one integrated circuit chip connected to said battery, wherein said  
8 integrated circuit chip is powered by said battery.

---

1

1 10. (As Amended) A system level device for battery and integrated circuit chip integration  
2 comprising:

3 a multi-chip module integration system, wherein said multi-chip module integration  
4 system comprises:

5 a multi-chip module;  
6 at least one battery connected to said multi-chip module; and  
7 at least one integrated circuit chip connected to said battery, wherein said  
8 integrated circuit chip is powered by said battery,  
9 wherein said at least one battery connects to a pair of opposed upright ends of said multi-  
10 chip module.

1 11. (As Amended) An integrated chip structure comprising:

2 an integrated circuit chip;  
3 a battery directly connected to said integrated circuit chip; and  
4 a package having a pair of opposed upright ends, said package connected to any of said  
5 battery and said integrated circuit chip.

1 14. (As Amended) The structure in claim 11, wherein said package surrounds said battery  
2 and said integrated circuit chip.

1 16. (As Amended) An integrated chip structure comprising:

2 a package having a pair of opposed upright ends;  
3 an integrated circuit chip mounted on said package; and  
4 a battery directly connected to said package and electrically connected to said integrated  
5 circuit chip.